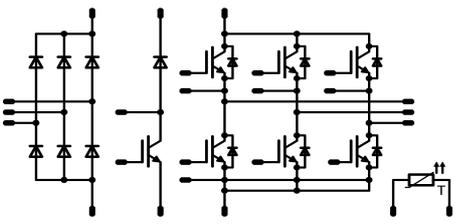
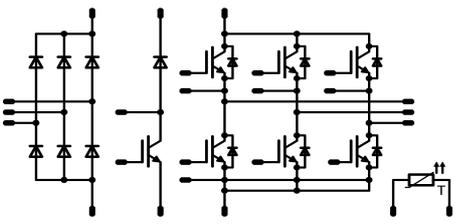
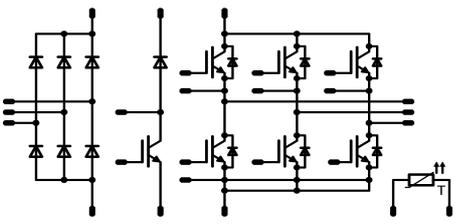




MiniSKiiP® 2 PIM	1200 V / 35 A				
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr style="background-color: #ccc;"> <th style="padding: 2px;">Features</th> </tr> <tr> <td style="padding: 2px;"> <ul style="list-style-type: none"> Solderless interconnection Trench Fieldstop IGBT4 technology Enhanced input rectifier </td> </tr> </table>	Features	<ul style="list-style-type: none"> Solderless interconnection Trench Fieldstop IGBT4 technology Enhanced input rectifier 	<table border="1" style="width: 100%; border-collapse: collapse;"> <tr style="background-color: #ccc;"> <th style="padding: 2px;">MiniSKiiP® 2 housing</th> </tr> <tr> <td style="text-align: center; padding: 5px;">  </td> </tr> </table>	MiniSKiiP® 2 housing	
Features					
<ul style="list-style-type: none"> Solderless interconnection Trench Fieldstop IGBT4 technology Enhanced input rectifier 					
MiniSKiiP® 2 housing					
					
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr style="background-color: #ccc;"> <th style="padding: 2px;">Target Applications</th> </tr> <tr> <td style="padding: 2px;"> <ul style="list-style-type: none"> Industrial Motor Drives </td> </tr> </table>	Target Applications	<ul style="list-style-type: none"> Industrial Motor Drives 	<table border="1" style="width: 100%; border-collapse: collapse;"> <tr style="background-color: #ccc;"> <th style="padding: 2px;">Schematic</th> </tr> <tr> <td style="text-align: center; padding: 5px;">  </td> </tr> </table>	Schematic	
Target Applications					
<ul style="list-style-type: none"> Industrial Motor Drives 					
Schematic					
					
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr style="background-color: #ccc;"> <th style="padding: 2px;">Types</th> </tr> <tr> <td style="padding: 2px;"> <ul style="list-style-type: none"> V23990-K220-A41-PM </td> </tr> </table>	Types	<ul style="list-style-type: none"> V23990-K220-A41-PM 			
Types					
<ul style="list-style-type: none"> V23990-K220-A41-PM 					

Maximum Ratings

$T_j=25^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
Rectifier Diode				
Repetitive peak reverse voltage	V_{RRM}		1600	V
DC forward current	I_{FAV}	$T_j=T_{jmax}$ $T_s=80^{\circ}\text{C}$	45	A
Surge forward current	I_{FSM}	$t_p=10\text{ms}$ $T_j=150^{\circ}\text{C}$	450	A
I2t-value	I^2t		1020	A^2s
Power dissipation	P_{tot}	$T_j=T_{jmax}$ $T_s=80^{\circ}\text{C}$	77	W
Maximum Junction Temperature	T_{jmax}		150	$^{\circ}\text{C}$
Inverter Switch \ Brake Switch				
Collector-emitter break down voltage	V_{CE}		1200	V
DC collector current	I_C	$T_j=T_{jmax}$ $T_s=80^{\circ}\text{C}$	38	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	105	A
Power dissipation	P_{tot}	$T_j=T_{jmax}$ $T_s=80^{\circ}\text{C}$	96	W
Gate-emitter peak voltage	V_{GE}		± 20	V
Short circuit ratings	t_{SC} V_{CC}	$T_j \leq 150^{\circ}\text{C}$ $V_{GE} = 15\text{V}$	10 800	μs V
Maximum Junction Temperature	T_{jmax}		175	$^{\circ}\text{C}$



Maximum Ratings

$T_i=25^{\circ}\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
-----------	--------	-----------	-------	------

Inverter Diode \ Brake Diode

Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
DC forward current	I_F	$T_j=T_{jmax}$ $T_s=80^{\circ}\text{C}$	25	A
Repetitive peak forward current	I_{FRM}	$t_p=10\text{ms}$ half sine	225	A
Power dissipation	P_{tot}	$T_j=T_{jmax}$ $T_s=80^{\circ}\text{C}$	62	W
Maximum Junction Temperature	T_{jmax}		175	$^{\circ}\text{C}$

Thermal Properties

Storage temperature	T_{stg}		-40...+125	$^{\circ}\text{C}$
Operation temperature under switching condition	T_{op}		-40...+($T_{jmax} - 25$)	$^{\circ}\text{C}$

Insulation Properties

Insulation voltage	V_{is}	$t=2\text{s}$ DC voltage	4000	V
Creepage distance			min 12.7	mm
Clearance			min 12.7	mm



Characteristic Values

Parameter	Symbol	Conditions					Value			Unit
		V_{GE} [V] or V_{GS} [V]	V_{CE} [V] or V_{DS} [V]	I_C [A] or I_F [A] or I_D [A]	T_j [°C]	Min	Typ	Max		

Rectifier Diode

Forward voltage	V_F				25	25 125	0,8	1,2 1,12	1,35	V
Threshold voltage (for power loss calc. only)	V_{th}					25 125		0,85 0,73		V
Slope resistance (for power loss calc. only)	r_t					25 125		14 15		mΩ
Reverse current	I_r			1600		25 125			0,1 1,1	mA
Thermal resistance chip to heatsink per chip	$R_{th(j-s)}$	Thermal grease thickness≤50μm λ=1W/mK						0,90		K/W

Inverter Switch\Brake Switch

Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,0012	25 150	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		35	25 150	1,6	1,87 2,3	2,15	V
Collector-emitter cut-off current incl. diode	I_{CES}		0	1200		25 150			0,05	mA
Gate-emitter leakage current	I_{GES}		20	0		25 150			300	nA
Integrated Gate resistor	R_{gint}							-		Ω
Turn-on delay time	$t_{d(on)}$	$R_{goff}=16\Omega$ $R_{gon}=16\Omega$	±15	600	35	25		78		ns
Rise time	t_r					150		79		
Turn-off delay time	$t_{d(off)}$					25		24		
Fall time	t_f					150		29		
Turn-on energy loss per pulse	E_{on}					25		196		
Turn-off energy loss per pulse	E_{off}	150		268						
Input capacitance	C_{ies}							1950		pF
Output capacitance	C_{oss}	f=1MHz	0	25		25		155		
Reverse transfer capacitance	C_{rss}							115		
Gate charge	Q_G	$V_{cc}=960V$	15		40	25		192		nC
Thermal resistance chip to heatsink per chip	$R_{th(j-s)}$	Thermal grease thickness≤50μm λ=1W/mK						1,07		K/W

Inverter Diode\Brake Diode

Diode forward voltage	V_F				35	25 150	1,5	2,36 2,34	2,65	V
Peak reverse recovery current	I_{RRM}	$R_{goff}=16\Omega$	±15	600	35	25		16		A
Reverse recovery time	t_{rr}					150		22,6		
Reverse recovered charge	Q_{rr}					25		336		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		550		
Reverse recovered energy	E_{rec}					25		2,2		
		150		5,36						
		25		63						
		150		0,77						
		25		2,07						
Thermal resistance chip to heatsink per chip	$R_{th(j-s)}$	Thermal grease thickness≤50μm λ=1W/mK						1,52		K/W

Thermistor

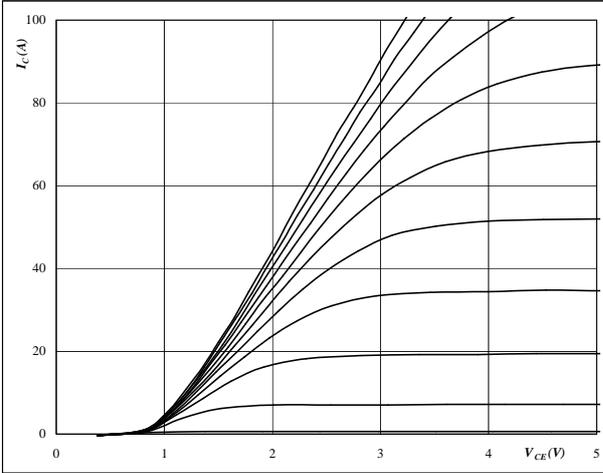
Rated resistance	R					T=25		1000		Ω
Deviation of R100	$\Delta_{R/R}$	$R_{100}=1670\Omega$				T=100	-3		3	%
R100	P					T=100		1670,3125		Ω
Power dissipation constant						T=25				mW/K
A-value	$B_{(25/50)}$	Tol. %				T=25		$7,635 \cdot 10^{-3}$		1/K
B-value	$B_{(25/100)}$	Tol. %				T=25		$1,731 \cdot 10^{-5}$		1/K²
Vincotech NTC Reference									E	



Inverter\Brake Characteristics

Figure 1 Inverter Switch\Brake Switch
Typical output characteristics

$I_C = f(V_{CE})$

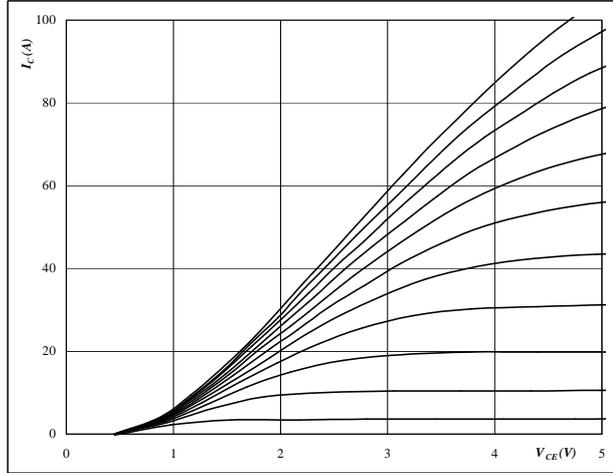


At

$t_p = 250 \mu s$
 $T_j = 25 \text{ }^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 2 Inverter Switch\Brake Switch
Typical output characteristics

$I_C = f(V_{CE})$

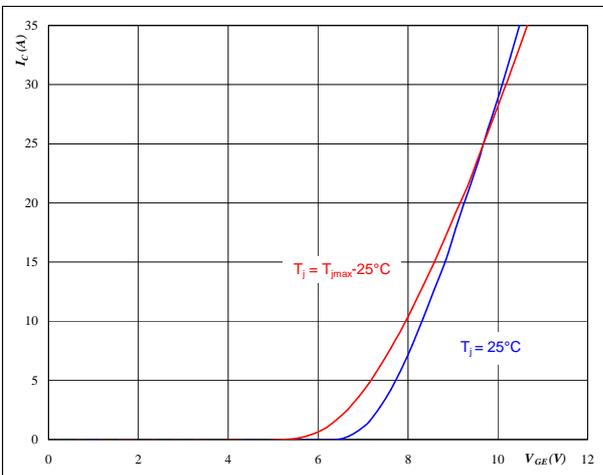


At

$t_p = 250 \mu s$
 $T_j = 150 \text{ }^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

Figure 3 Inverter Switch\Brake Switch
Typical transfer characteristics

$I_C = f(V_{GE})$

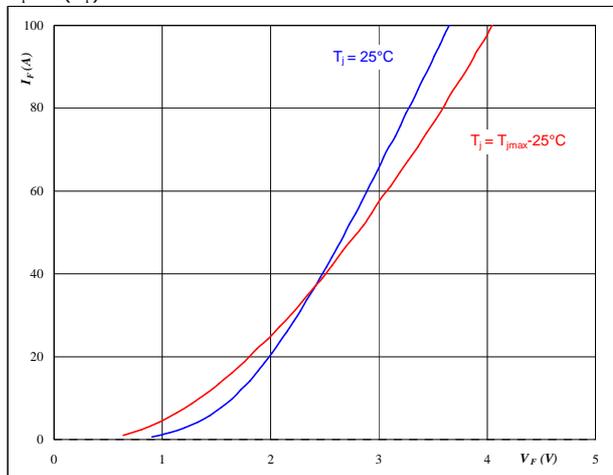


At

$t_p = 250 \mu s$
 $V_{CE} = 10 V$

Figure 4 Inverter Diode\Brake Diode
Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



At

$t_p = 250 \mu s$

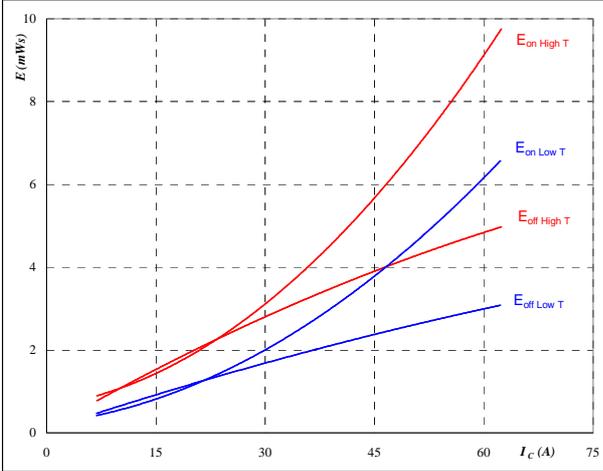


Inverter\Brake Characteristics

Figure 5 Inverter Switch\Brake Switch

Typical switching energy losses as a function of collector current

$E = f(I_C)$



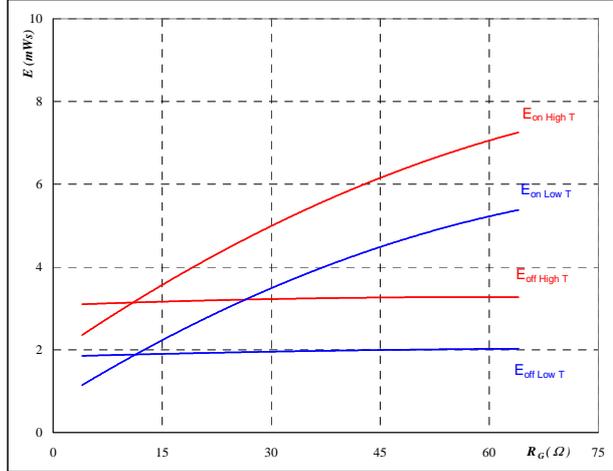
With an inductive load at

- $T_j = 25/150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $R_{gon} = 16 \text{ } \Omega$
- $R_{goff} = 16 \text{ } \Omega$

Figure 6 Inverter Switch\Brake Switch

Typical switching energy losses as a function of gate resistor

$E = f(R_G)$



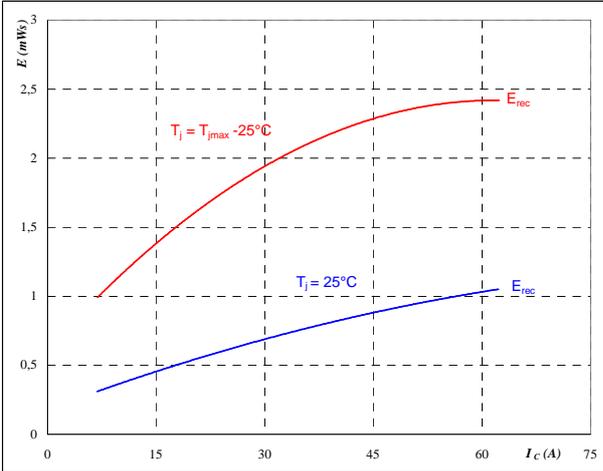
With an inductive load at

- $T_j = 25/150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $I_C = 35 \text{ A}$

Figure 7 Inverter Switch\Brake Switch

Typical reverse recovery energy loss as a function of collector current

$E_{rec} = f(I_C)$



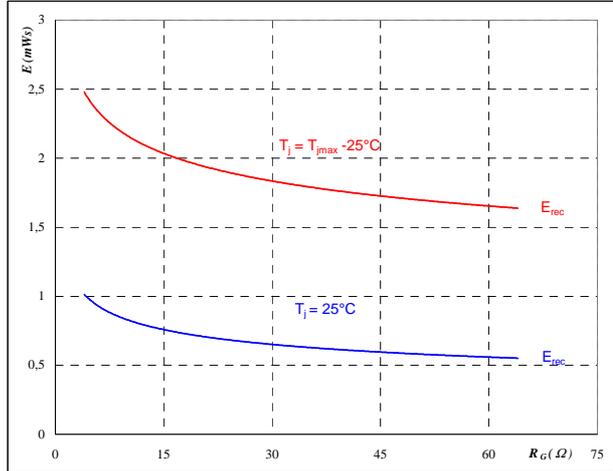
With an inductive load at

- $T_j = 25/150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $R_{gon} = 16 \text{ } \Omega$

Figure 8 Inverter Switch\Brake Switch

Typical reverse recovery energy loss as a function of gate resistor

$E_{rec} = f(R_G)$



With an inductive load at

- $T_j = 25/150 \text{ } ^\circ\text{C}$
- $V_{CE} = 600 \text{ V}$
- $V_{GE} = \pm 15 \text{ V}$
- $I_C = 35 \text{ A}$

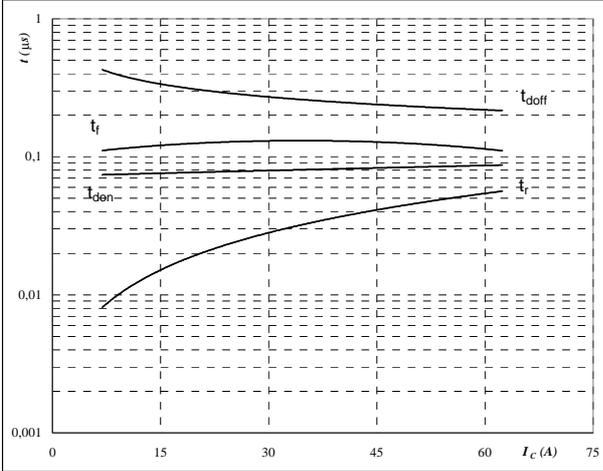


Inverter\Brake Characteristics

Figure 9 Inverter Switch\Brake Switch

Typical switching times as a function of collector current

$t = f(I_C)$



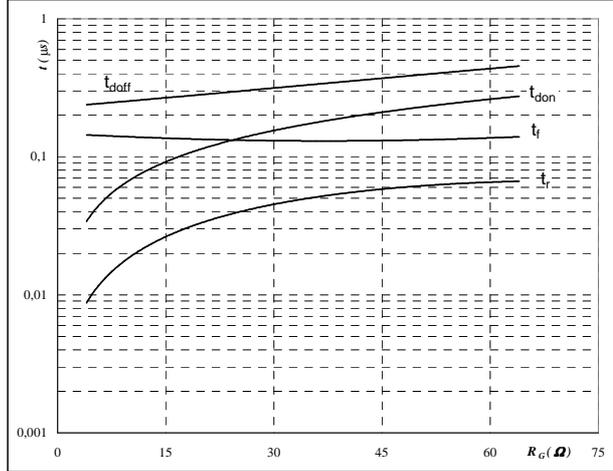
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	16	Ω
$R_{goff} =$	16	Ω

Figure 10 Inverter Switch\Brake Switch

Typical switching times as a function of gate resistor

$t = f(R_G)$



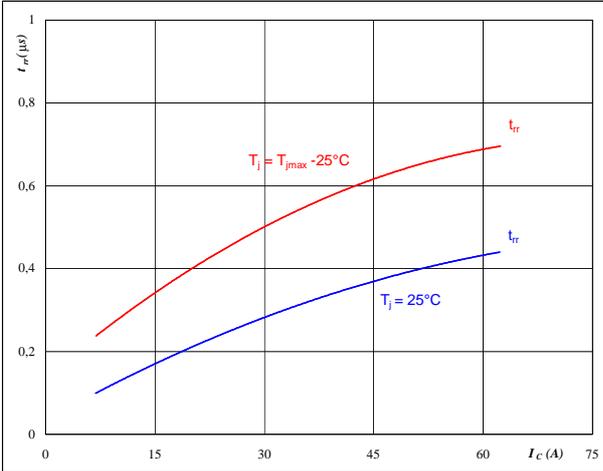
With an inductive load at

$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	35	A

Figure 11 Inverter Diode\Brake Diode

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$



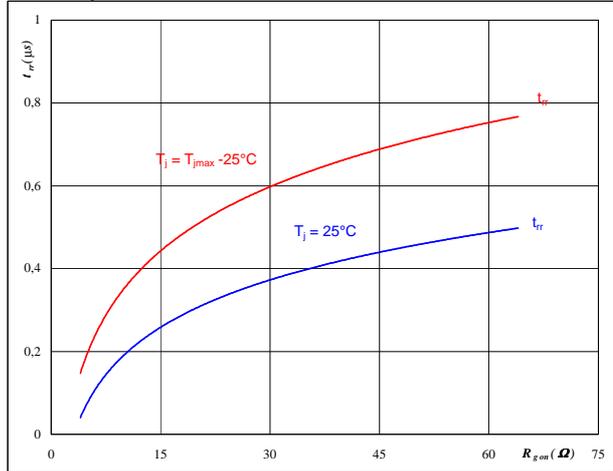
At

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	16	Ω

Figure 12 Inverter Diode\Brake Diode

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



At

$T_j =$	25/150	°C
$V_R =$	600	V
$I_F =$	35	A
$V_{GE} =$	±15	V

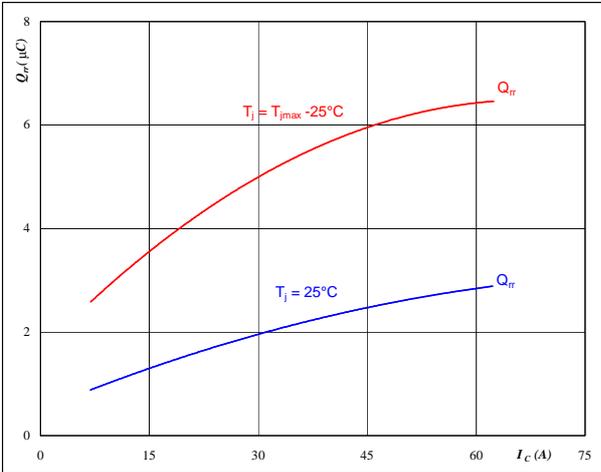


Inverter\Brake Characteristics

Figure 13 Inverter Diode\Brake Diode

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_C)$$



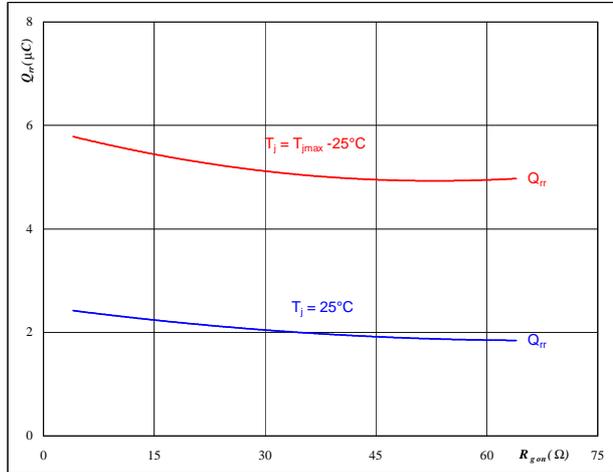
At

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	16	Ω

Figure 14 Inverter Diode\Brake Diode

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$



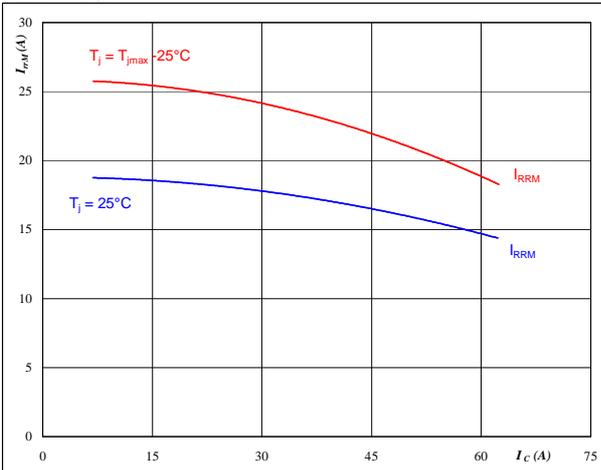
At

$T_j =$	25/150	°C
$V_R =$	600	V
$I_F =$	35	A
$V_{GE} =$	±15	V

Figure 15 Inverter Diode\Brake Diode

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_C)$$



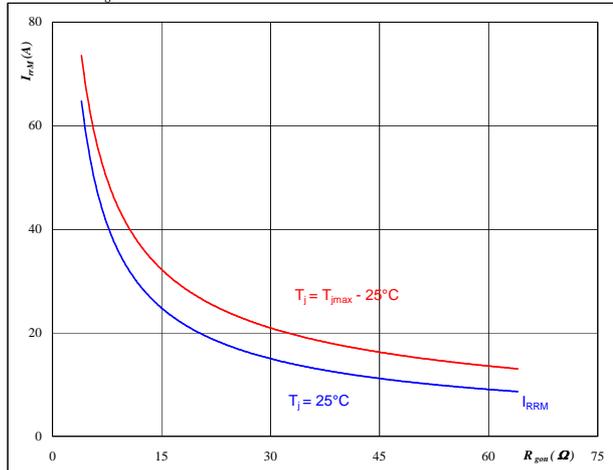
At

$T_j =$	25/150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	16	Ω

Figure 16 Inverter Diode\Brake Diode

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$



At

$T_j =$	25/150	°C
$V_R =$	600	V
$I_F =$	35	A
$V_{GE} =$	±15	V

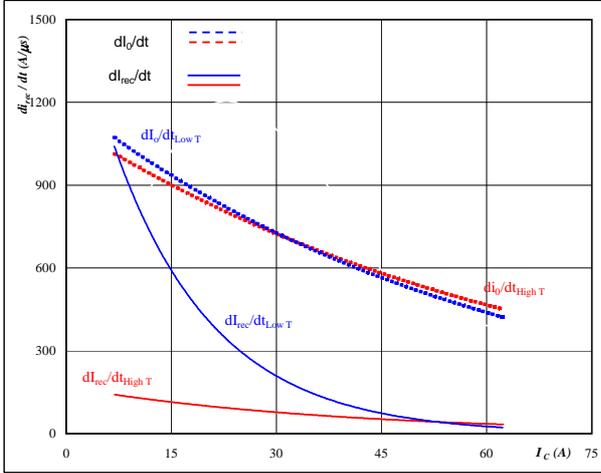


Inverter\Brake Characteristics

Figure 17 Inverter Diode\Brake Diode

Typical rate of fall of forward and reverse recovery current as a function of collector current

$$dI_0/dt, dI_{rec}/dt = f(I_C)$$

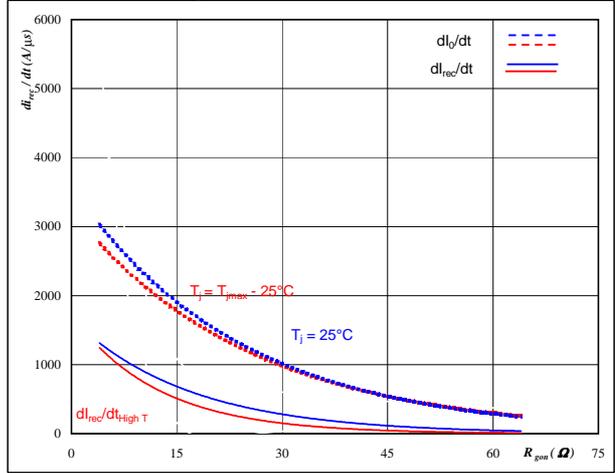


At
 $T_j = 25/150$ °C
 $V_{CE} = 600$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 16$ Ω

Figure 18 Inverter Diode\Brake Diode

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$dI_0/dt, dI_{rec}/dt = f(R_{gon})$$

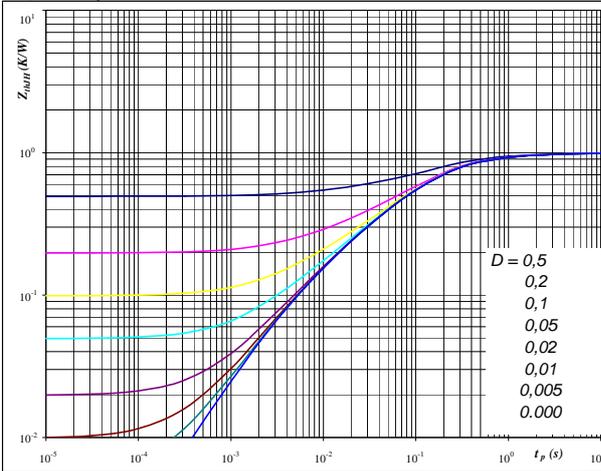


At
 $T_j = 25/150$ °C
 $V_R = 600$ V
 $I_F = 35$ A
 $V_{GE} = \pm 15$ V

Figure 19 Inverter Switch\Brake Switch

IGBT transient thermal impedance as a function of pulse width

$$Z_{thjH} = f(t_p)$$



At
 $D = t_p / T$
 $R_{thjH} = 0,99$ K/W

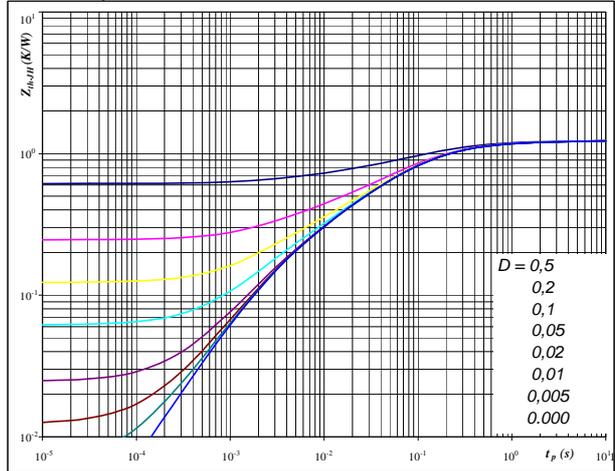
IGBT thermal model values

R (K/W)	Tau (s)
0,10	1,5E+00
0,31	2,7E-01
0,41	8,9E-02
0,13	1,4E-02
0,03	2,8E-03

Figure 20 Inverter Diode\Brake Diode

FWD transient thermal impedance as a function of pulse width

$$Z_{thjH} = f(t_p)$$



At
 $D = t_p / T$
 $R_{thjH} = 1,23$ K/W

FWD thermal model values

R (K/W)	Tau (s)
0,08	2,1E+00
0,33	2,4E-01
0,50	6,6E-02
0,22	1,3E-02
0,10	2,3E-03

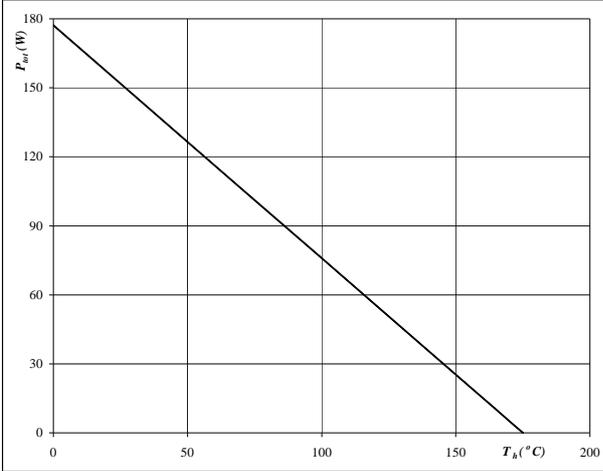


Inverter\Brake Characteristics

Figure 21 Inverter Switch\Brake Switch

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

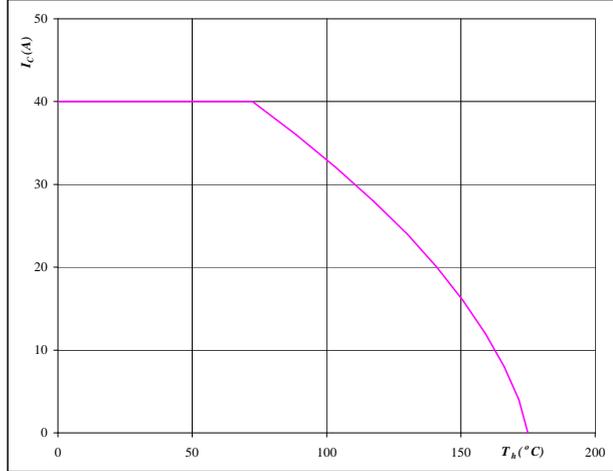


At
 $T_j = 175$ °C

Figure 22 Inverter Switch\Brake Switch

Collector current as a function of heatsink temperature

$I_c = f(T_h)$

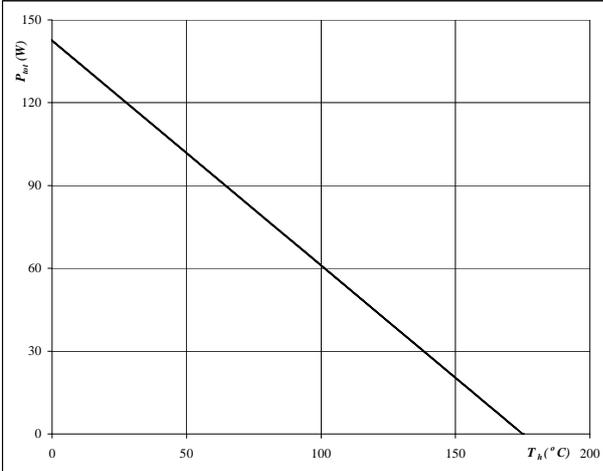


At
 $T_j = 175$ °C
 $V_{GE} = 15$ V

Figure 23 Inverter Diode\Brake Diode FWD

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

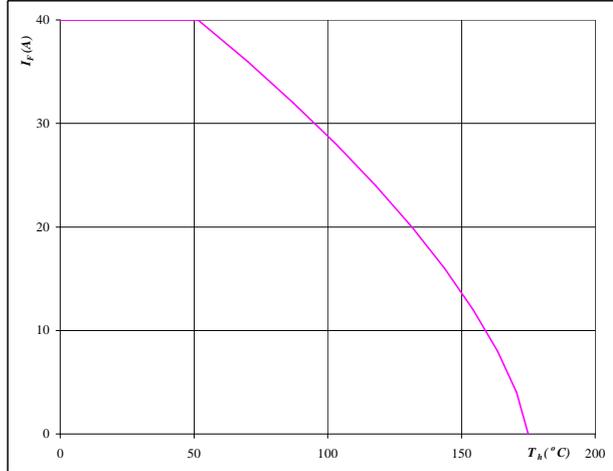


At
 $T_j = 175$ °C

Figure 24 Inverter Diode\Brake Diode FWD

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



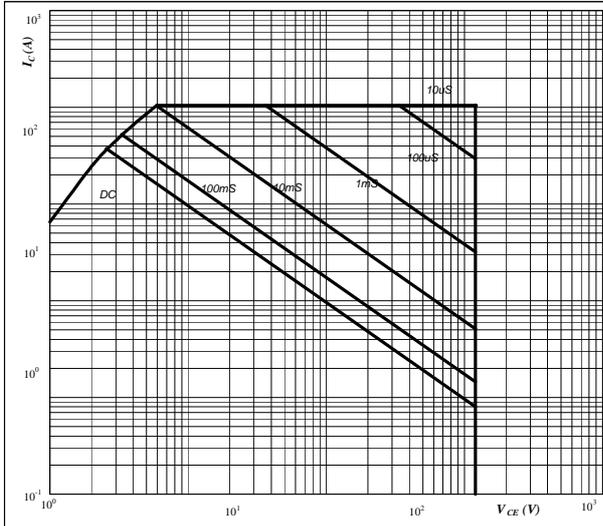
At
 $T_j = 175$ °C



Inverter\Brake Characteristics

Figure 25 Inverter Switch\Brake Switch
Safe operating area as a function of collector-emitter voltage

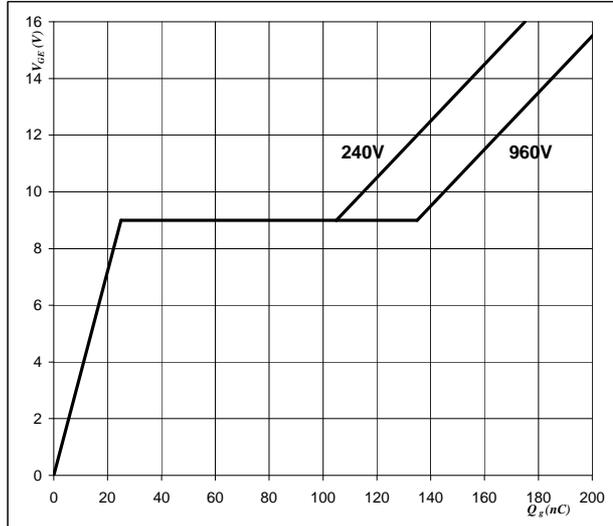
$I_C = f(V_{CE})$



At
 $D =$ single pulse
 $T_h = 80$ °C
 $V_{GE} = \pm 15$ V
 $T_j = T_{jmax}$ °C

Figure 26 Inverter Switch\Brake Switch
Gate voltage vs Gate charge

$V_{GE} = f(Q_{GE})$



At
 $I_C = 35$ A

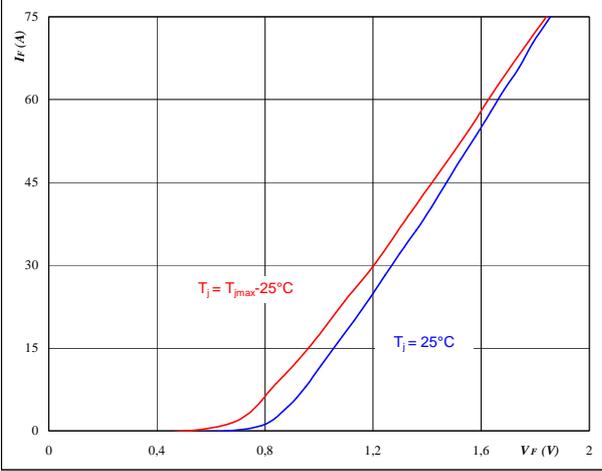


Rectifier Diode

Figure 1 Rectifier Diode diode

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$

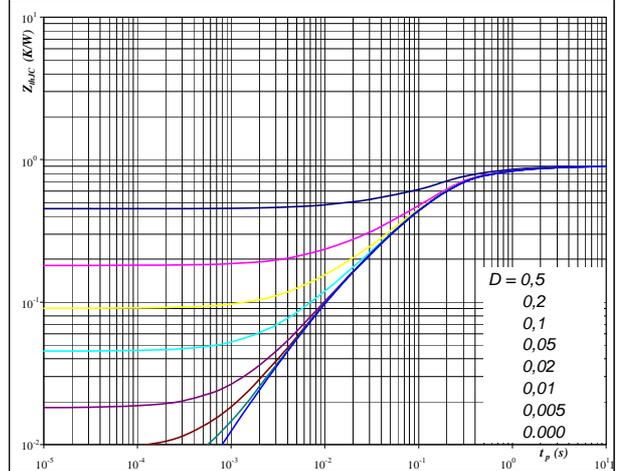


At
 $t_p = 250 \mu s$

Figure 2 Rectifier Diode diode

Diode transient thermal impedance as a function of pulse width

$Z_{thH} = f(t_p)$

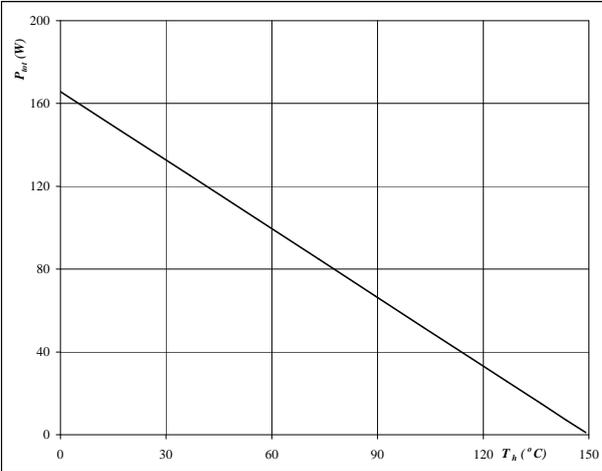


At
 $D = t_p / T$
 $R_{thH} = 0,905 \text{ K/W}$

Figure 3 Rectifier Diode diode

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

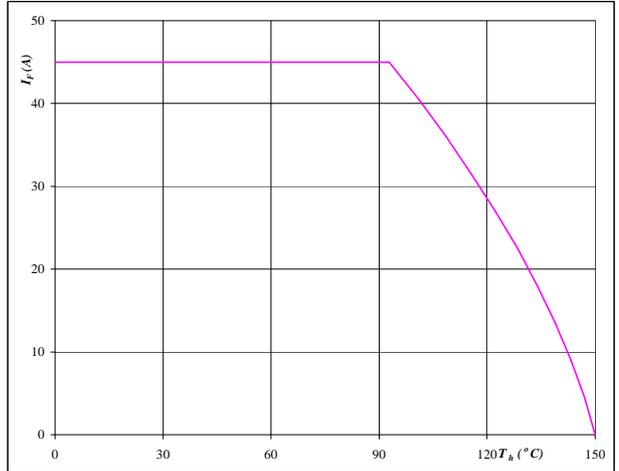


At
 $T_j = 150 \text{ °C}$

Figure 4 Rectifier Diode diode

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



At
 $T_j = 150 \text{ °C}$

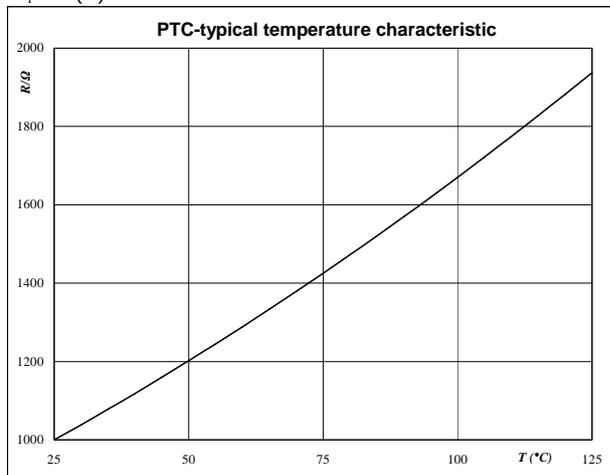


Thermistor

Figure 1 Thermistor

**Typical PTC characteristic
as a function of temperature**

$$R_T = f(T)$$





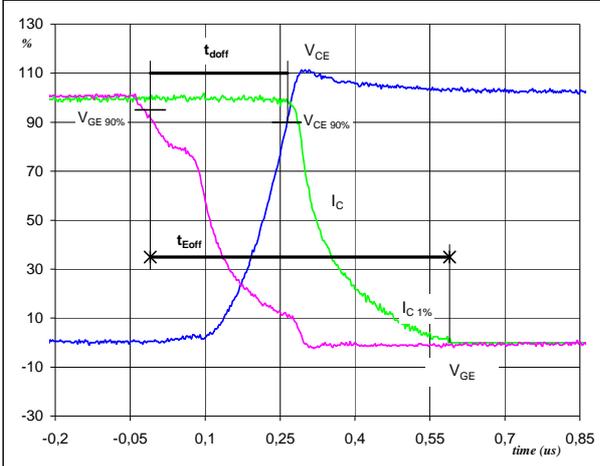
Switching Definitions Inverter

General conditions

T_j	=	150 °C
R_{gon}	=	16 Ω
R_{goff}	=	16 Ω

Figure 1 IGBT

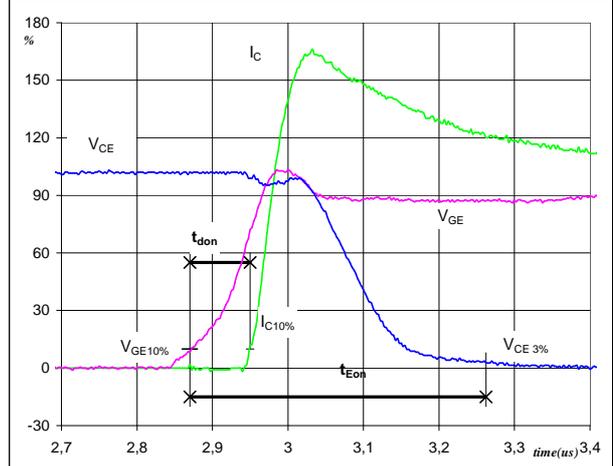
Turn-off Switching Waveforms & definition of t_{doff} t_{Eoff}
 (t_{Eoff} = integrating time for E_{off})



V_{GE} (0%) =	-15	V
V_{GE} (100%) =	15	V
V_C (100%) =	600	V
I_C (100%) =	35	A
t_{doff} =	0,27	μ s
t_{Eoff} =	0,60	μ s

Figure 2 IGBT

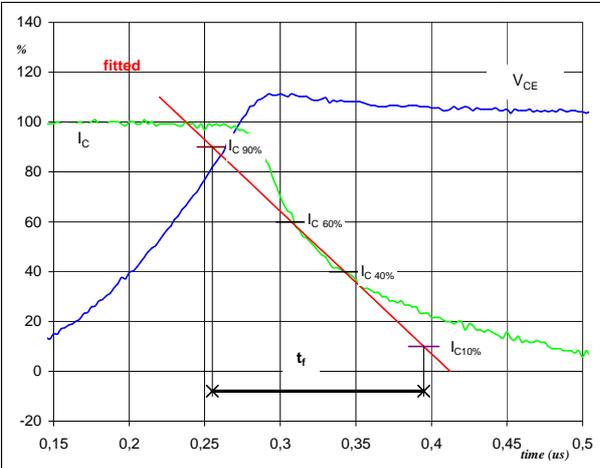
Turn-on Switching Waveforms & definition of t_{don} t_{Eon}
 (t_{Eon} = integrating time for E_{on})



V_{GE} (0%) =	-15	V
V_{GE} (100%) =	15	V
V_C (100%) =	600	V
I_C (100%) =	35	A
t_{don} =	0,08	μ s
t_{Eon} =	0,39	μ s

Figure 3 IGBT

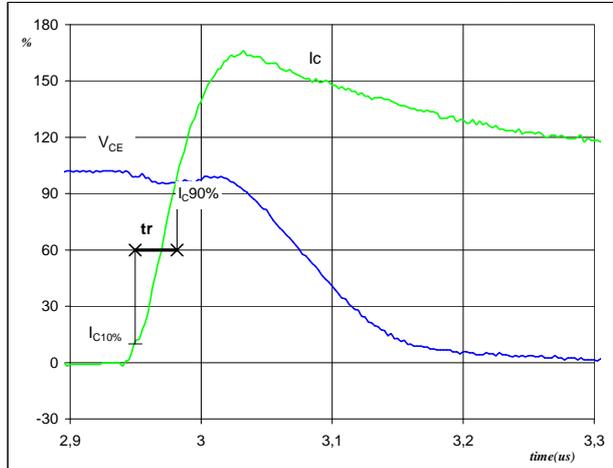
Turn-off Switching Waveforms & definition of t_f



V_C (100%) =	600	V
I_C (100%) =	35	A
t_f =	0,13	μ s

Figure 4 IGBT

Turn-on Switching Waveforms & definition of t_r

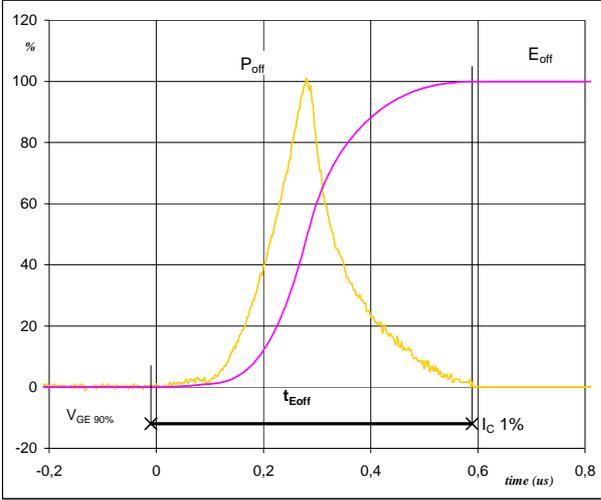


V_C (100%) =	600	V
I_C (100%) =	35	A
t_r =	0,03	μ s



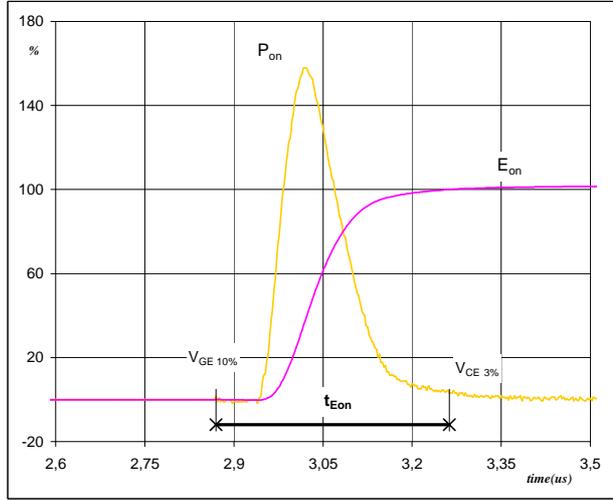
Switching Definitions Inverter

Figure 5 IGBT
Turn-off Switching Waveforms & definition of t_{Eoff}



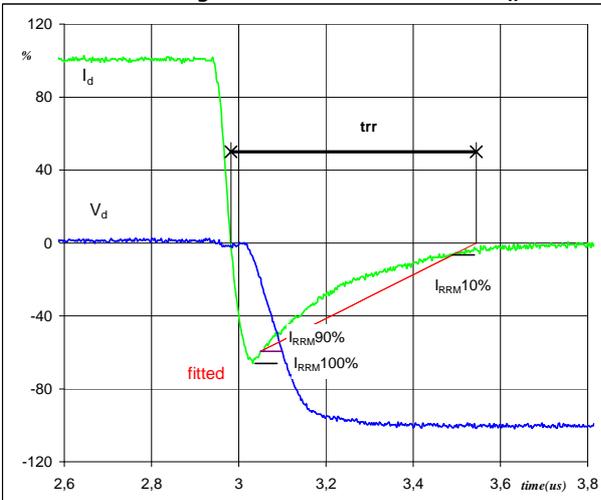
$P_{off} (100\%) = 20,88 \text{ kW}$
 $E_{off} (100\%) = 3,18 \text{ mJ}$
 $t_{Eoff} = 0,60 \text{ } \mu\text{s}$

Figure 6 IGBT
Turn-on Switching Waveforms & definition of t_{Eon}



$P_{on} (100\%) = 20,88 \text{ kW}$
 $E_{on} (100\%) = 3,84 \text{ mJ}$
 $t_{Eon} = 0,39 \text{ } \mu\text{s}$

Figure 7 FWD
Turn-off Switching Waveforms & definition of t_{tr}



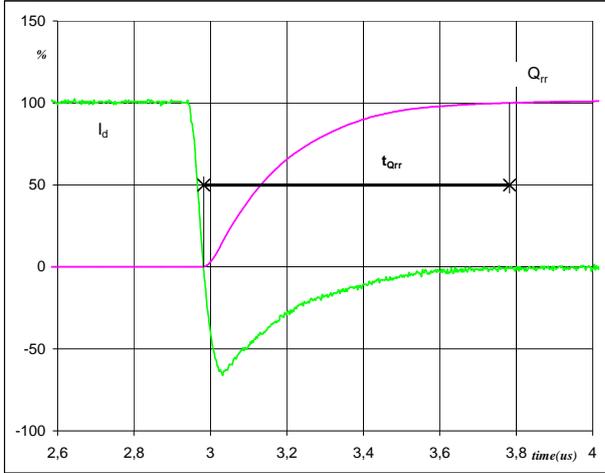
$V_d (100\%) = 600 \text{ V}$
 $I_d (100\%) = 35 \text{ A}$
 $I_{RRM} (100\%) = 23 \text{ A}$
 $t_{tr} = 0,57 \text{ } \mu\text{s}$



Switching Definitions Inverter

Figure 8 FWD

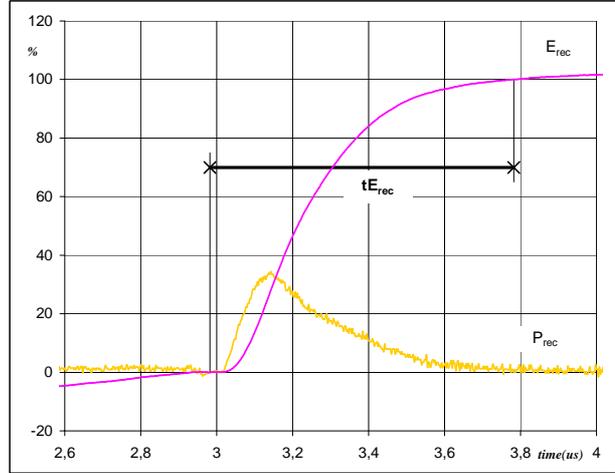
Turn-on Switching Waveforms & definition of t_{Qrr}
 (t_{Qrr} = integrating time for Q_{rr})



I_d (100%) =	35	A
Q_{rr} (100%) =	5,40	μC
t_{Qrr} =	0,80	μs

Figure 9 FWD

Turn-on Switching Waveforms & definition of t_{Erec}
 (t_{Erec} = integrating time for E_{rec})

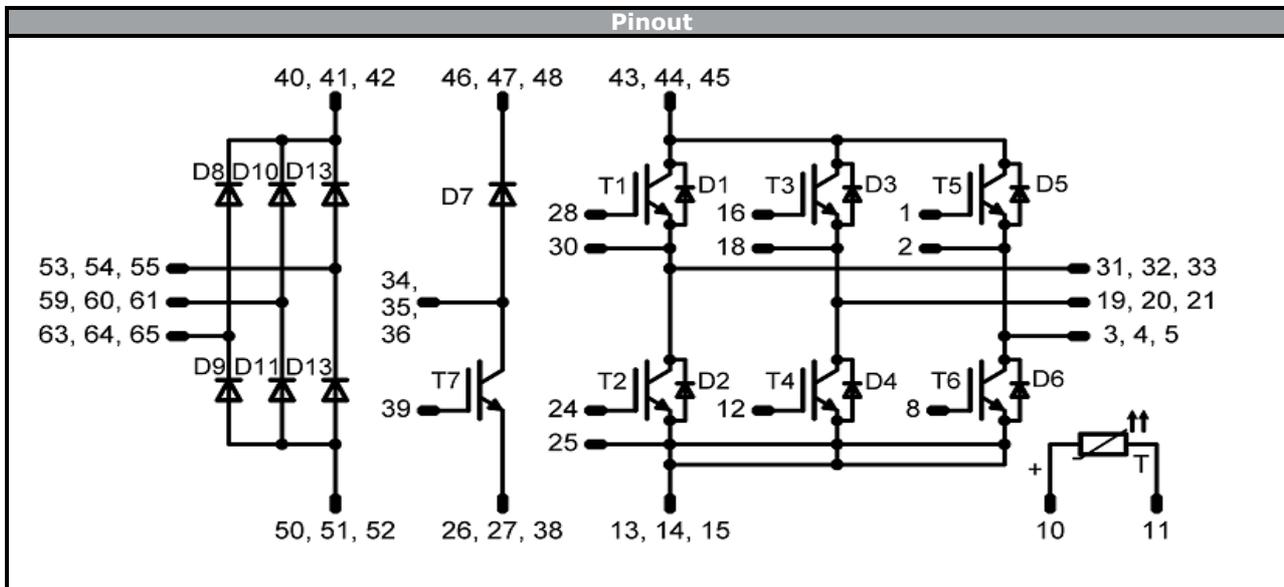
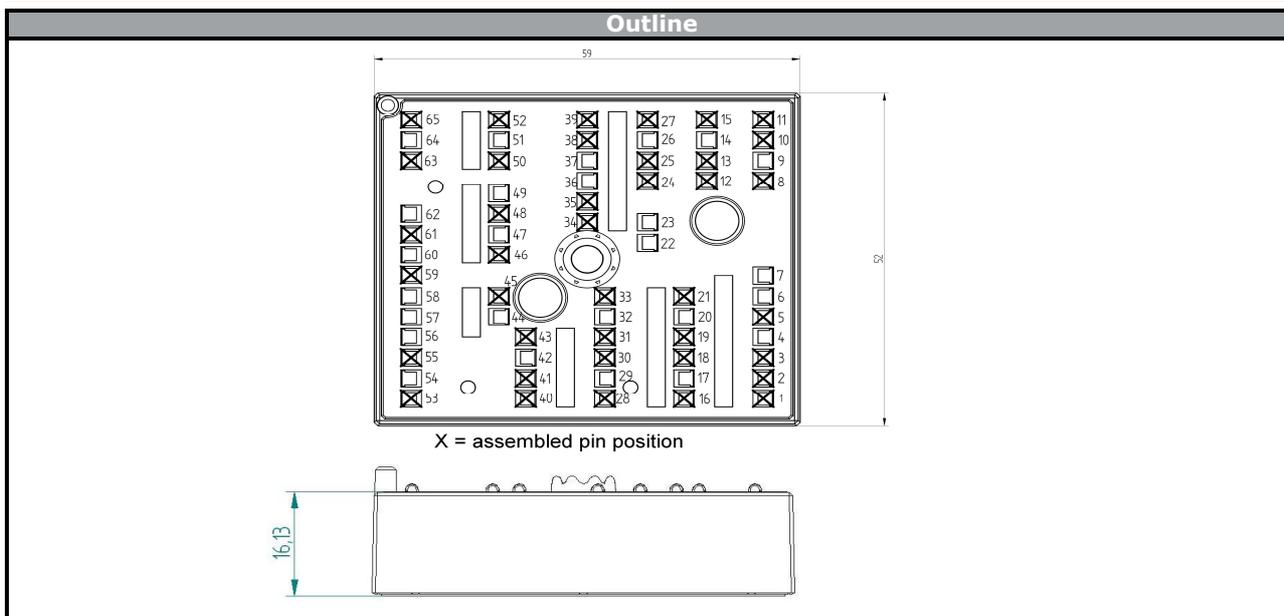


P_{rec} (100%) =	20,88	kW
E_{rec} (100%) =	2,10	mJ
t_{Erec} =	0,80	μs



Ordering Code and Marking - Outline - Pinout

Ordering Code & Marking															
Version	Ordering Code														
with std lid (black V23990-K12-T-PM)	V23990-K220-A41-/0A/-PM														
with std lid (black V23990-K12-T-PM) and P12	V23990-K220-A41-/1A/-PM														
with thin lid (white V23990-K13-T-PM)	V23990-K220-A41-/0B/-PM														
with thin lid (white V23990-K13-T-PM) and P12	V23990-K220-A41-/1B/-PM														
	<table border="1"> <thead> <tr> <th>Text</th> <th>Vinco</th> <th>Date code</th> <th>Name&Ver</th> <th>UL</th> <th>Lot</th> <th>Serial</th> </tr> </thead> <tbody> <tr> <td></td> <td>Vinco</td> <td>WWYY</td> <td>NNNNNNVV</td> <td>UL</td> <td>LLLLL</td> <td>SSSS</td> </tr> </tbody> </table>	Text	Vinco	Date code	Name&Ver	UL	Lot	Serial		Vinco	WWYY	NNNNNNVV	UL	LLLLL	SSSS
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	Vinco	WWYY	NNNNNNVV	UL	LLLLL	SSSS									
<table border="1"> <thead> <tr> <th>Datamatrix</th> <th>Type&Ver</th> <th>Lot number</th> <th>Serial</th> <th>Date code</th> <th></th> <th></th> </tr> </thead> <tbody> <tr> <td></td> <td>TTTTTTVV</td> <td>LLLLL</td> <td>SSSS</td> <td>WWYY</td> <td></td> <td></td> </tr> </tbody> </table>	Datamatrix	Type&Ver	Lot number	Serial	Date code				TTTTTTVV	LLLLL	SSSS	WWYY			
Datamatrix	Type&Ver	Lot number	Serial	Date code											
	TTTTTTVV	LLLLL	SSSS	WWYY											



Identification					
ID	Component	Voltage	Current	Function	Comment
T1,T2,T3,T4,T5,T6	IGBT	1200 V	35 A	Inverter Switch	
D1,D2,D3,D4,D5,D6	FWD	1200 V	35 A	Inverter Diode	
T7	IGBT	1200 V	35 A	Brake Switch	
D7	FWD	1200 V	35 A	Brake Diode	
D8,D9,D10,D11,D12,D13	Rectifier	1600 V	25 A	Rectifier Diode	
T	PTC			Thermistor	



Packaging instruction			
Standard packaging quantity (SPQ)	72	>SPQ Standard	<SPQ Sample

Handling instruction
Handling instructions for MiniSkiiP® 2 packages see vincotech.com website.

Package data
Package data for MiniSkiiP® 2 packages see vincotech.com website.

Document No.:	Date:	Modification:	Pages
V23990-K220-A41-D4-14	26 Feb. 2016	New brand, Disclaimer	all

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